

20 V, 7 A NPN low VCEsat transistor

16 January 2025

**Product data sheet** 

### 1. General description

NPN low  $V_{CEsat}$  transistor in a medium power and flat lead SOT89 (SC-62) Surface-Mounted Device (SMD) plastic package.

PNP complement: PBSS4021PX

### 2. Features and benefits

- Very low collector-emitter saturation voltage V<sub>CEsat</sub>
- High collector current capability  ${\rm I}_{\rm C}$  and  ${\rm I}_{\rm CM}$
- High collector current gain (h\_{FE}) at high  ${\rm I}_{\rm C}$
- · High energy efficiency due to less heat generation
- AEC-Q101 qualified

### 3. Applications

- Loadswitch
  - Battery-driven devices
- Power management
- Charging circuits
- Power switches (e.g. motors, fans)

## 4. Quick reference data

Table 1. Quick reference data							
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V <sub>CEO</sub>	collector-emitter voltage	open base		-	-	20	V
I <sub>C</sub>	collector current			-	-	7	A
I <sub>CM</sub>	peak collector current	single pulse; t <sub>p</sub> ≤ 1 ms		-	-	15	A
R <sub>CEsat</sub>	collector-emitter saturation resistance	$I_C$ = 5 A; $I_B$ = 500 mA; pulsed; $t_p$ ≤ 300 μs; δ ≤ 0.02; $T_{amb}$ = 25 °C		-	15	28	mΩ

## 5. Pinning information

#### Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	E	emitter		С
2	С	collector		R F
3	В	base		B — [x E
			SOT89	sym042



### 6. Ordering information

Table 3. Ordering information						
Type number	Package					
	Name	Description	Version			
PBSS4021NX		plastic, surface-mounted package; 3 leads; 1.5 mm pitch; 4.5 mm x 2.5 mm x 1.5 mm body	<u>SOT89</u>			

### 7. Marking

Table 4. Marking codes				
Type number	Marking code[1]			
PBSS4021NX	%6D			

[1] % = placeholder for manufacturing site code

### 8. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>CBO</sub>	collector-base voltage	open emitter		-	20	V
V <sub>CEO</sub>	collector-emitter voltage	open base		-	20	V
V <sub>EBO</sub>	emitter-base voltage	open collector		-	5	V
I <sub>C</sub>	collector current			-	7	А
I <sub>CM</sub>	peak collector current	single pulse; t <sub>p</sub> ≤ 1 ms		-	15	А
I <sub>B</sub>	base current			-	1	А
P <sub>tot</sub>	total power dissipation $T_{amb} \le 25 \text{ °C}$	$T_{amb} \le 25 \ ^{\circ}C$	[1]	-	600	mW
		[2]	-	1.5	W	
			[3]	-	1.45	W
			[4]	-	2.45	W
			[5]	-	2.5	W
Tj	junction temperature			-	150	°C
T <sub>amb</sub>	ambient temperature			-55	150	°C
T <sub>stg</sub>	storage temperature			-65	150	°C

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided, 35 µm copper, tin-plated and standard footprint.

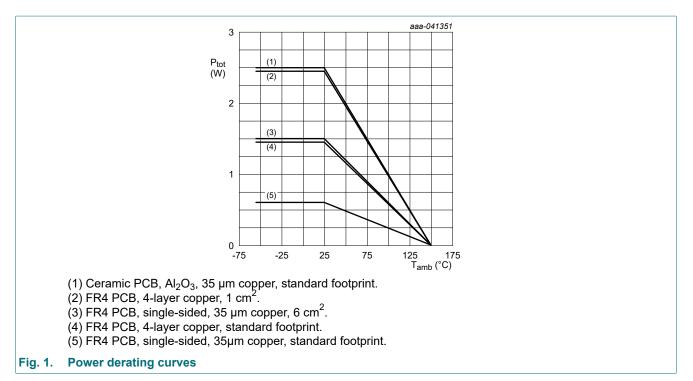
[2] Device mounted on an FR4 PCB, single-sided,  $35 \ \mu m$  copper, tin-plated, mounting pad for collector 6 cm<sup>2</sup>.

[3] Device mounted on an FR4 PCB, 4-layer, tin-plated and standard footprint.

[4] Device mounted on an FR4 PCB, 4-layer, tin-plated, mounting pad for collector 1 cm<sup>2</sup>.

[5] Device mounted on a ceramic PCB, Al<sub>2</sub>O<sub>3</sub>, single-sided, 35 µm copper, tin-plated and standard footprint.

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### 9. Thermal characteristics

#### Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R <sub>th(j-a)</sub> thermal resistance from junction to ambient	thermal resistance from	in free air	[1]	-	-	208	K/W
		[2]	-	-	83	K/W	
			[3]	-	-	86	K/W
			[4]	-	-	51	K/W
			[5]	-	-	50	K/W
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point			-	-	20	K/W

[1] Device mounted on an FR4 PCB, single-sided, 35 µm copper, tin-plated and standard footprint.

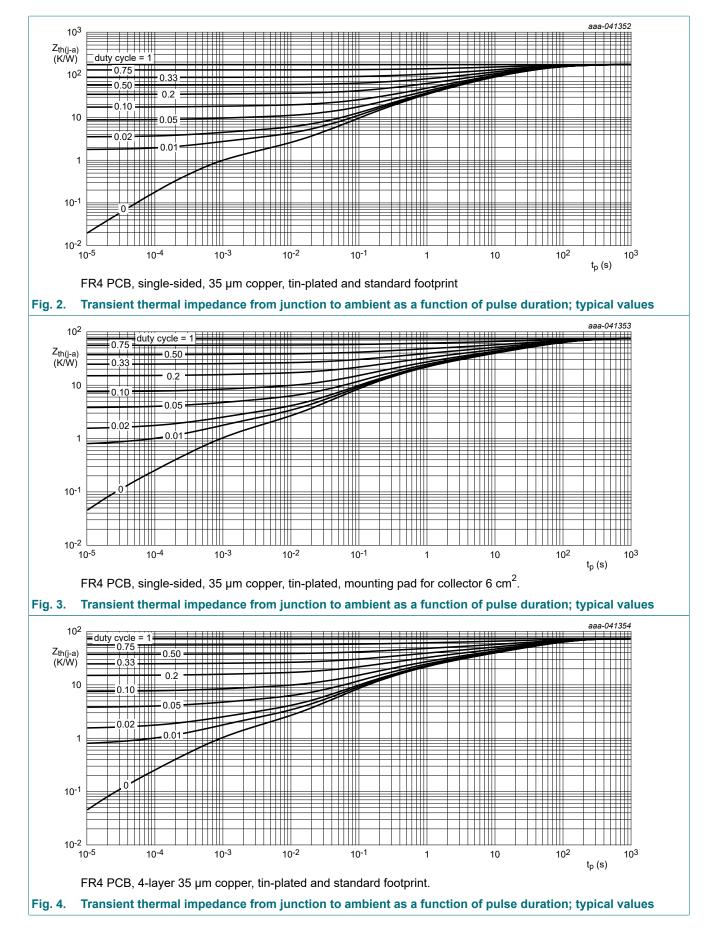
[2] Device mounted on an FR4 PCB, single-sided, 35 µm copper, tin-plated, mounting pad for collector 6 cm<sup>2</sup>.

[3] Device mounted on an FR4 PCB, 4-layer, tin-plated and standard footprint.

[4] Device mounted on an FR4 PCB, 4-layer, tin-plated, mounting pad for collector 1 cm<sup>2</sup>

[5] Device mounted on a ceramic PCB, Al<sub>2</sub>O<sub>3</sub>, single-sided, 35 µm copper, tin-plated and standard footprint.

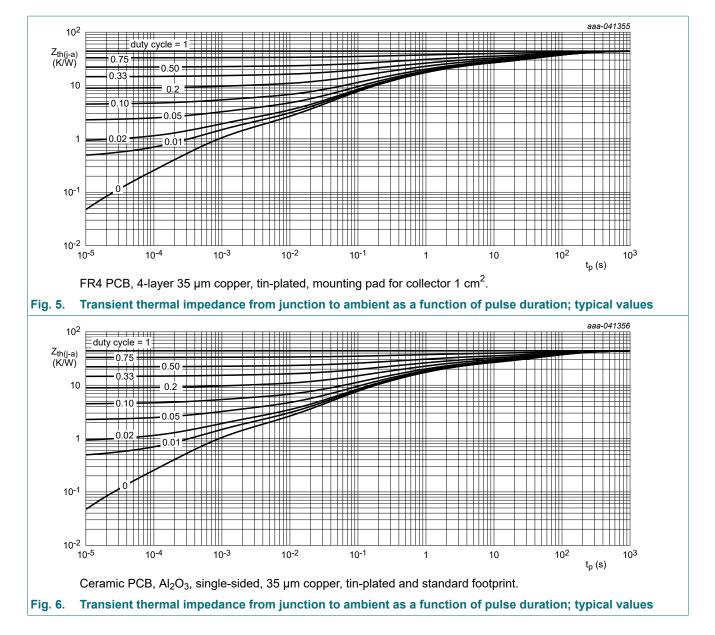
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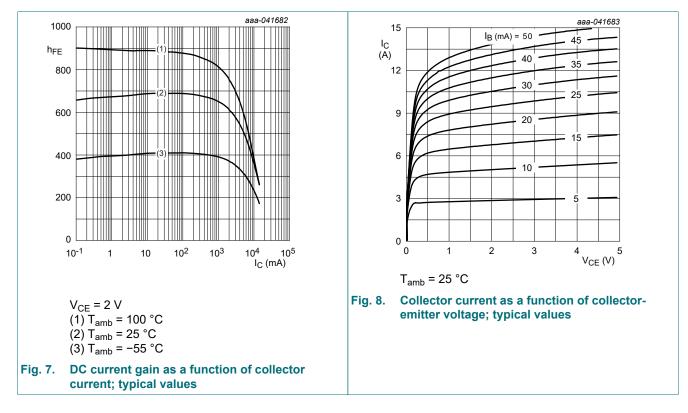
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# **10. Characteristics**

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>(BR)CBO</sub>	collector-base breakdown voltage	I <sub>C</sub> = 100 μA; I <sub>E</sub> = 0 A; T <sub>amb</sub> = 25 °C	20	-	-	V
V <sub>(BR)CEO</sub>	collector-emitter breakdown voltage	I <sub>C</sub> = 10 mA; I <sub>B</sub> = 0 A; T <sub>amb</sub> = 25 °C	20	-	-	V
V <sub>(BR)EBO</sub>	emitter-base breakdown voltage	I <sub>E</sub> = 100 μA; I <sub>C</sub> = 0 A; T <sub>amb</sub> = 25 °C	5	-	-	V
I <sub>CBO</sub>	collector-base cut-off	V <sub>CB</sub> = 20 V; I <sub>E</sub> = 0 A; T <sub>amb</sub> = 25 °C	-	-	100	nA
	current	V <sub>CB</sub> = 20 V; I <sub>E</sub> = 0 A; T <sub>j</sub> = 150 °C	-	-	50	μA
I <sub>CES</sub>	collector-emitter cut-off current	$V_{CE}$ = 16 V; $V_{BE}$ = 0 V; $T_{amb}$ = 25 °C	-	-	100	nA
I <sub>EBO</sub>	emitter-base cut-off current	V <sub>EB</sub> = 5 V; I <sub>C</sub> = 0 A; T <sub>amb</sub> = 25 °C	-	-	100	nA
h <sub>FE</sub>	DC current gain	$ \begin{array}{l} V_{CE} \texttt{= 2 V; } I_{C} \texttt{= 0.5 A; pulsed; } t_{p} \texttt{\leq} \\ \texttt{300 } \mus; \delta \texttt{\leq 0.02; } T_{amb} \texttt{= 25 °C} \end{array} $	300	620	-	
		$V_{CE}$ = 2 V; I <sub>C</sub> = 1 A; pulsed; t <sub>p</sub> ≤ 300 µs; $\delta$ ≤ 0.02; T <sub>amb</sub> = 25 °C	300	600	-	
		$ \begin{array}{l} V_{CE} \texttt{= 2 V; } I_{C} \texttt{= 2 A; pulsed; } t_{p} \texttt{\leq 300 } \mu \texttt{s}; \\ \delta \texttt{\leq } 0.02;  T_{amb} \texttt{= 25 °C} \end{array} $	300	570	-	
		$\label{eq:Vce} \begin{array}{l} V_{CE} = 2 \; V; \; I_{C} = 4 \; A; \; pulsed; \; t_{p} \leq \; 300 \; \mu s; \\ \delta \leq \; 0.02; \; T_{amb} = 25 \; ^{\circ} C \end{array}$	250	510	-	
		$V_{CE}$ = 2 V; I <sub>C</sub> = 8 A; pulsed; t <sub>p</sub> ≤ 300 µs; $\delta$ ≤ 0.02; T <sub>amb</sub> = 25 °C	100	400	-	
V <sub>CEsat</sub>	collector-emitter saturation voltage	I <sub>C</sub> = 1 A; I <sub>B</sub> = 10 mA; pulsed; t <sub>p</sub> ≤ 300 μs; δ ≤ 0.02; T <sub>amb</sub> = 25 °C	-	30	60	mV
		$I_{C}$ = 1 A; $I_{B}$ = 50 mA; pulsed; $t_{p} \le$ 300 μs; δ ≤ 0.02; $T_{amb}$ = 25 °C	-	20	38	mV
		$I_C$ = 2 A; $I_B$ = 40 mA; pulsed; $t_p \le$ 300 μs; δ ≤ 0.02; $T_{amb}$ = 25 °C	-	40	75	mV
		$I_C$ = 4 A; $I_B$ = 40 mA; pulsed; $t_p \le$ 300 μs; δ ≤ 0.02; $T_{amb}$ = 25 °C	-	80	140	mV
		I <sub>C</sub> = 4 A; I <sub>B</sub> = 200 mA; pulsed; t <sub>p</sub> ≤ 300 μs; δ ≤ 0.02; T <sub>amb</sub> = 25 °C	-	65	120	mV
		I <sub>C</sub> = 7 A; I <sub>B</sub> = 350 mA; pulsed; t <sub>p</sub> ≤ 300 μs; δ ≤ 0.02; T <sub>amb</sub> = 25 °C	-	110	210	mV
R <sub>CEsat</sub>	collector-emitter saturation resistance	I <sub>C</sub> = 5 A; I <sub>B</sub> = 500 mA; pulsed; t <sub>p</sub> ≤ 300 μs; δ ≤ 0.02; T <sub>amb</sub> = 25 °C	-	15	28	mΩ
V <sub>BEsat</sub>	base-emitter saturation voltage	I <sub>C</sub> = 1 A; I <sub>B</sub> = 100 mA; pulsed; t <sub>p</sub> ≤ 300 μs; δ ≤ 0.02; T <sub>amb</sub> = 25 °C	-	0.85	0.9	V
		I <sub>C</sub> = 4 A; I <sub>B</sub> = 400 mA; pulsed; t <sub>p</sub> ≤ 300 μs; δ ≤ 0.02; T <sub>amb</sub> = 25 °C	-	0.99	1.05	V
V <sub>BEon</sub>	base-emitter turn-on	$V_{CE}$ = 2 V; I <sub>C</sub> = 2 A; pulsed; t <sub>p</sub> ≤ 300 µs;		0.76	0.85	V

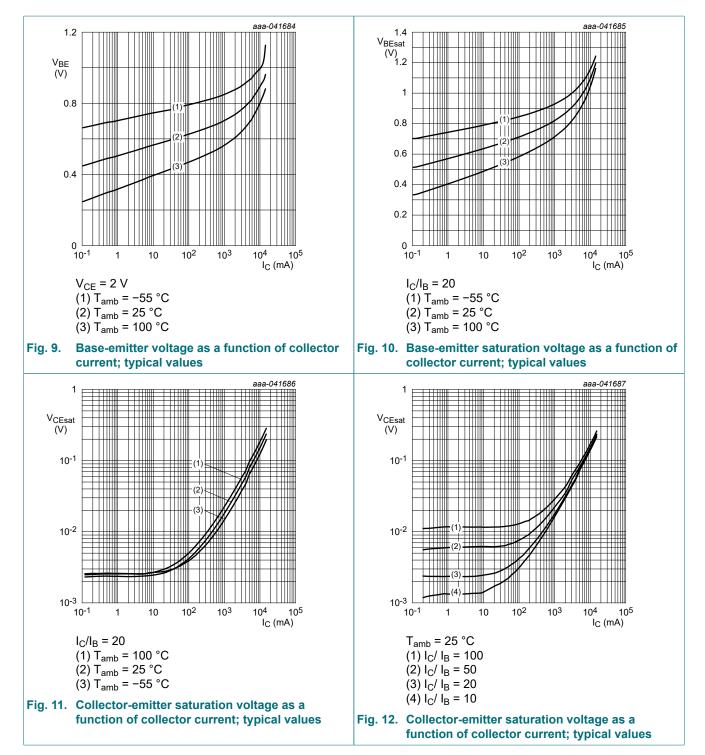
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Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
t <sub>d</sub>	delay time	V <sub>CC</sub> = 12.5 V; I <sub>C</sub> = 1 A; I <sub>Bon</sub> = 50 mA;	-	40	-	ns
t <sub>r</sub>	rise time	I <sub>Boff</sub> = -50 mA; T <sub>amb</sub> = 25 °C	-	35	-	ns
t <sub>on</sub>	turn-on time		-	75	-	ns
t <sub>s</sub>	storage time		-	430	-	ns
t <sub>f</sub>	fall time		-	65	-	ns
t <sub>off</sub>	turn-off time		-	495	-	ns
f <sub>T</sub>	transition frequency	$V_{CE}$ = 10 V; I <sub>C</sub> = 100 mA; f = 100 MHz; T <sub>amb</sub> = 25 °C	-	115	-	MHz
C <sub>c</sub>	collector capacitance	$V_{CB}$ = 10 V; I <sub>E</sub> = 0 A; i <sub>e</sub> = 0 A; f = 1 MHz; T <sub>amb</sub> = 25 °C	-	70	-	pF

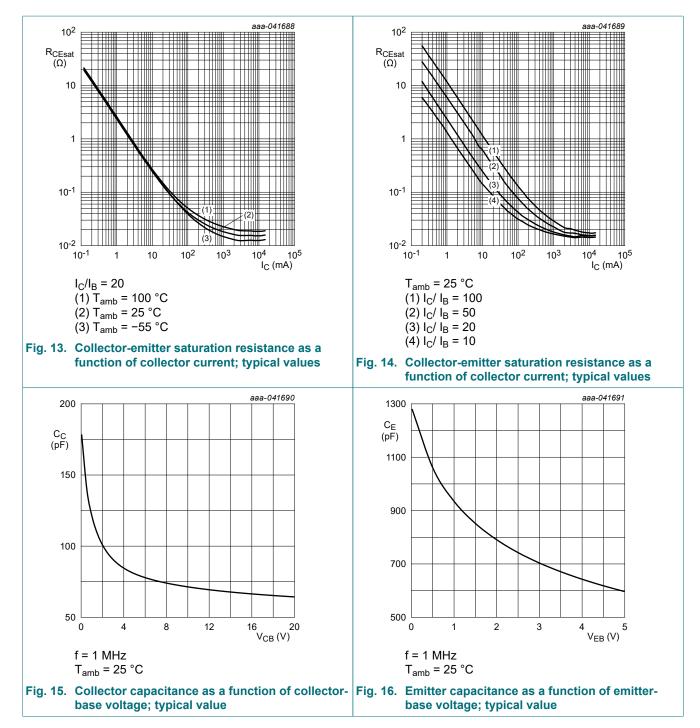


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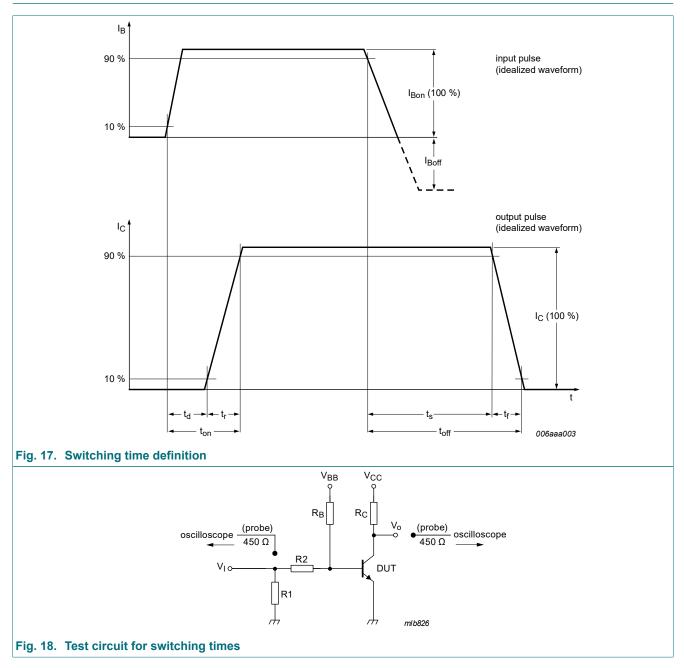
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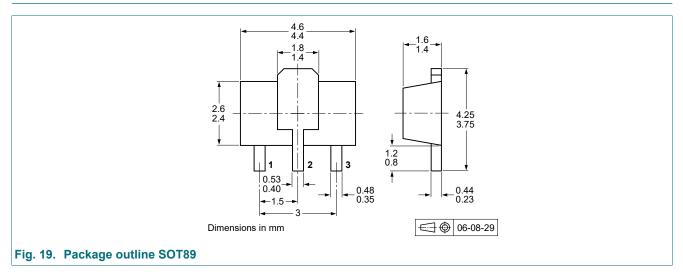
# **11. Test information**



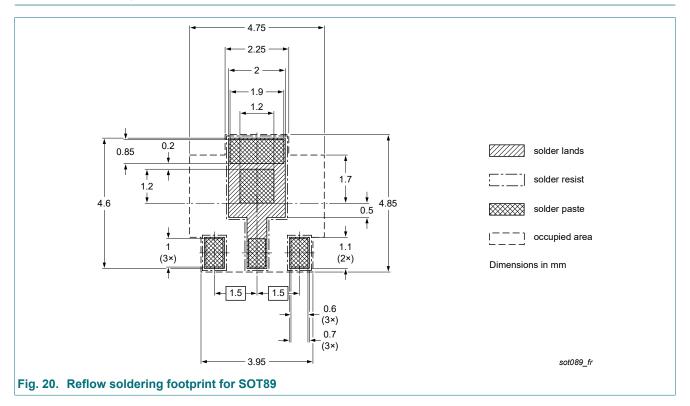
#### **Quality information**

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101* - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

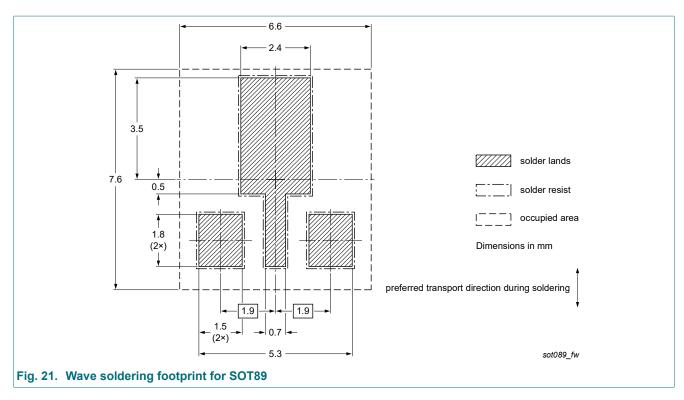
# 12. Package outline



#### 13. Soldering



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# 14. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PBSS4021NX v.4	20250116	Product data sheet	-	PBSS4021NX v.3
Modifications:	<ul><li>Editorial updat</li><li>New graphics</li></ul>	e and values are added.		
PBSS4021NX v.3	20121211	Product data sheet	-	PBSS4021NX v.2
PBSS4021NX v.2	20121009	Product data sheet	-	PBSS4021NX v.1
FD3340211NA V.2				

PBSS4021NX

# 15. Legal information

#### **Data sheet status**

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

 Please consult the most recently issued document before initiating or completing a design.

- [2] The term 'short data sheet' is explained in section "Definitions".
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